TOSHIBA LED Lamp InGaAlP Orange Light Emission

TLOH190P(F)

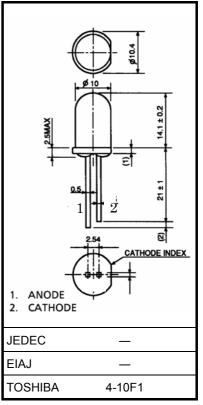
Panel Circuit Indicator

Unit in mm

- Lead(Pb)-free products (lead: Sn-Ag-Cu)
- 10mm package
- InGaAlP technology
- All plastic mold type.
- Colorless clear lens
- Low drive current, high intensity orange light emission Recommended forward current: IF = 1~20mA (DC)
- All plastic molded lens, provides an excellent on-off contrast ratio.
- Fast response time, capable of pulse operation.
- High power luminous intensity
- Without stand-offs
- Applications: Suitable for outdoor message signboard, safety equipment.

Maximum Ratings (Ta = 25°C)

Characteristic	Symbol	Rating	Unit
Forward current (DC)	lF	50	mA
Reverse voltage	V _R	4	٧
Power dissipation	P _D	125	mW
Operating temperature range	T _{opr}	-30~85	°C
Storage temperature range	T _{stg}	-40~120	°C



Weight: 1.0g



For part availability and ordering information please call Toll Free: 800.984.5337 Website: www.marktechopto.com | Email: info@marktechopto.com



Electrical And Optical Characteristics (Ta = 25°C)

Characteristic		Symbol	Test Condition		Min	Тур.	Max	Unit
Forward voltage		V _F	I _F = 20mA		_	2.1	2.5	V
Reverse current		I _R	V _R = 4V		_	_	50	μA
Luminous intensity	TLOH190P(F)	- I _V	I _F = 20mA	(NI-4-)	8500	33000	_	mcd
	TLOH190P(XY,F)			(Note)	15300	_	73600	
Peak emission v	vavelength	λ _P	I _F = 20mA		_	(612)	_	nm
Spectral line half width		Δλ	I _F = 20mA		_	15	_	nm
Dominant wavelength		λ _d	I _F = 20mA		_	605	_	nm

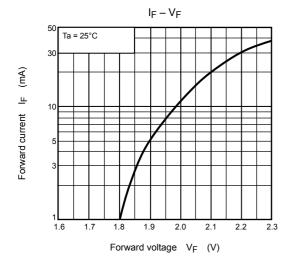
(Note):Lamps are classified into the following ranks according to their luminous intensity , and packed in boxes by each rank .

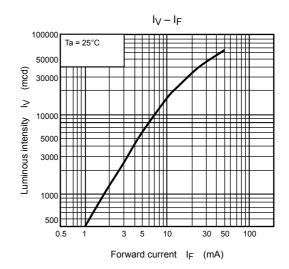
W: 8500 - 2300mcd, X: 15300 - 41400mcd, Y: 27200mcd -

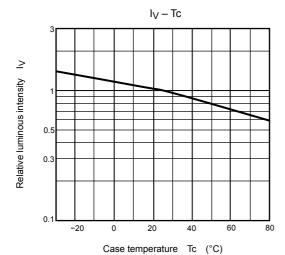
Precaution

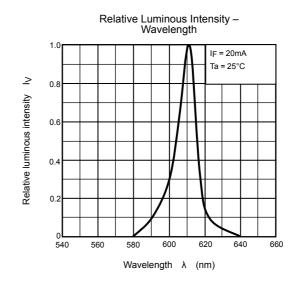
Please be careful of the followings

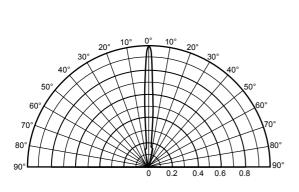
- Soldering temperature: 260°Cmax soldering time: 3s max (Soldering portion of lead: up to 1.6mm from the body of the device)
- If the lead is formed, the lead should be formed up to 1.6mm from the body of the device without forming stress to the resin. Soldering should be performed after lead forming.
- This visible LED lamp also emits some IR light. If a photodetector is located near the LED lamp, please ensure that it will not be affected by this IR light.







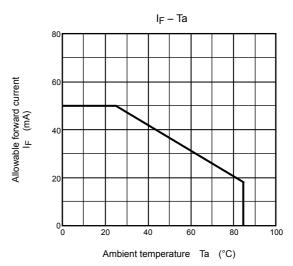




Radiation Pattern

Ta = 25°C

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RESTRICTIONS ON PRODUCT USE

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- TOSHIBA is continually working to improve the quality and reliability of its products. Nevertheless, semiconductor devices in general can malfunction or fail due to their inherent electrical sensitivity and vulnerability to physical stress. It is the responsibility of the buyer, when utilizing TOSHIBA products, to comply with the standards of safety in making a safe design for the entire system, and to avoid situations in which a malfunction or failure of such TOSHIBA products could cause loss of human life, bodily injury or damage to property. In developing your designs, please ensure that TOSHIBA products are used within specified operating ranges as set forth in the most recent TOSHIBA products specifications. Also, please keep in mind the precautions and conditions set forth in the "Handling Guide for Semiconductor Devices," or "TOSHIBA Semiconductor Reliability Handbook" etc..
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